

Title (en)  
INSULATION DISPLACEMENT CONNECTION, AND METHOD FOR CONNECTING TWO COMPONENTS

Title (de)  
SCHNEID-KLEMM-VERBINDUNG, SOWIE VERFAHREN ZUR VERBINDUNG ZWEIER BAUTEILE

Title (fr)  
CONNEXION À BORNE GUILLOTINE ET PROCÉDÉ POUR CONNECTER DEUX COMPOSANTS

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Abstract (en)  
[origin: WO2008055786A2] The invention relates to an insulation displacement connection (37) and to a method for connecting two components (52, 54) - especially for high current application - said connection comprising a first insulation displacement element (15) which is fixed to a first component (52), and a second insulation displacement element (22) which is fixed to a second component (54). The two insulation displacement elements (15, 22) can be inserted into each other in the direction of assembly, the first and/or second insulation displacement element (15, 22) being fixed to the first and/or second component (52, 54) in such a way that the insulation displacement element (15) is moveably arranged in a plane (49) transversal to the direction of assembly (50).

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